

DATA SHEET

**PMBFJ308; PMBFJ309;
PMBFJ310**

**N-channel silicon field-effect
transistors**

Product specification
Supersedes data of April 1995
File under Discrete Semiconductors, SC07

1996 Sep 11

N-channel silicon field-effect transistors

PMBFJ308; PMBFJ309; PMBFJ310

FEATURES

- Low noise
- Interchangeability of drain and source connections
- High gain.

APPLICATIONS

- AM input stage in car radios
- VHF amplifiers
- Oscillators and mixers.

DESCRIPTION

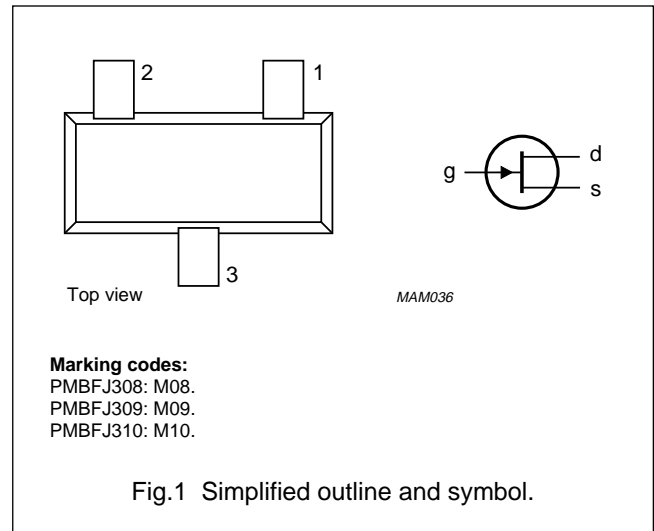
N-channel symmetrical silicon junction field-effect transistors in a SOT23 package.

CAUTION

The device is supplied in an antistatic package. The gate-source input must be protected against static discharge during transport or handling.

PINNING - SOT23

| PIN | SYMBOL | DESCRIPTION |
|-----|--------|-------------|
| 1 | s | source |
| 2 | d | drain |
| 3 | g | gate |



QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|-------------|-----------------------------|--|------|------|------|
| V_{DS} | drain-source voltage | | – | ±25 | V |
| V_{GSoff} | gate-source cut-off voltage | $V_{DS} = 10\text{ V}; I_D = 1\ \mu\text{A}$ | | | |
| | PMBFJ308 | | –1 | –6.5 | V |
| | PMBFJ309 | | –1 | –4 | V |
| | PMBFJ310 | | –2 | –6.5 | V |
| I_{DSS} | drain current | $V_{GS} = 0; V_{DS} = 10\text{ V}$ | | | |
| | PMBFJ308 | | 12 | 60 | mA |
| | PMBFJ309 | | 12 | 30 | mA |
| | PMBFJ310 | | 24 | 60 | mA |
| P_{tot} | total power dissipation | up to $T_{amb} = 25\text{ °C}$ | – | 250 | mW |
| $ y_{fs} $ | forward transfer admittance | $V_{DS} = 10\text{ V}; I_D = 10\text{ mA}$ | 10 | – | mS |

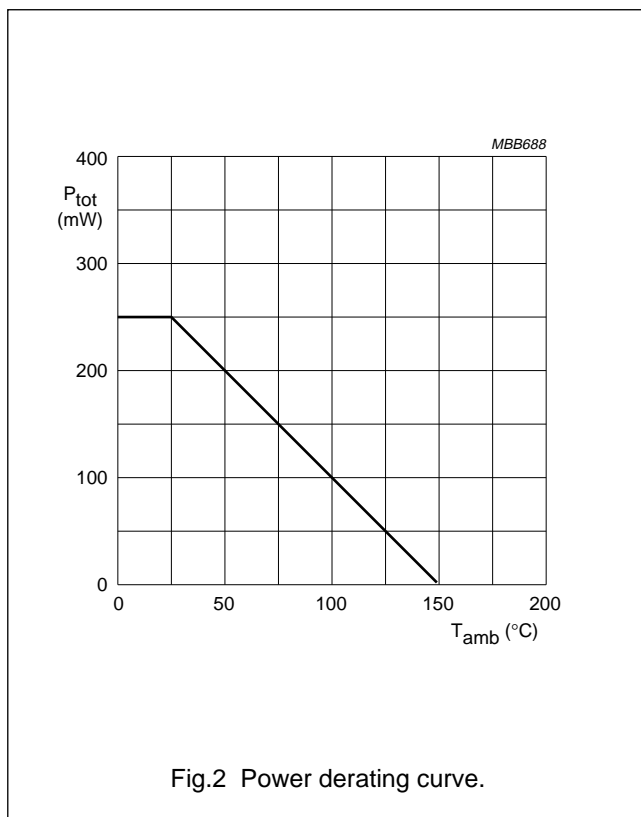
N-channel silicon field-effect transistors

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|-----------|--------------------------------|--|------|----------|------------------|
| V_{DS} | drain-source voltage | | – | ± 25 | V |
| V_{GSO} | gate-source voltage | open drain | – | –25 | V |
| V_{GDO} | gate-drain voltage | open source | – | –25 | V |
| I_G | forward gate current (DC) | | – | 50 | mA |
| P_{tot} | total power dissipation | up to $T_{amb} = 25\text{ }^\circ\text{C}$ | – | 250 | mW |
| T_{stg} | storage temperature | | –65 | 150 | $^\circ\text{C}$ |
| T_j | operating junction temperature | | – | 150 | $^\circ\text{C}$ |



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THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | VALUE | UNIT |
|---------------|---|-------|------|
| $R_{th\ j-a}$ | thermal resistance from junction to ambient; note 1 | 500 | K/W |

Note

1. Device mounted on an FR4 printed-circuit board.

STATIC CHARACTERISTICS

$T_j = 25\text{ °C}$; unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---------------|----------------------------------|--|------|------|------|---------------|
| $V_{(BR)GSS}$ | gate-source breakdown voltage | $I_G = -1\ \mu\text{A}$; $V_{DS} = 0$ | -25 | - | - | V |
| V_{GSoff} | gate-source cut-off voltage | $I_D = 1\ \mu\text{A}$; $V_{DS} = 10\ \text{V}$ | | | | V |
| | PMBFJ308 | | -1 | - | -6.5 | V |
| | PMBFJ309 | | -1 | - | -4 | V |
| | PMBFJ310 | | -2 | - | -6.5 | V |
| V_{GSS} | gate-source forward voltage | $I_G = 1\ \text{mA}$; $V_{DS} = 0$ | - | - | 1 | V |
| I_{DSS} | drain current | $V_{DS} = 10\ \text{V}$; $V_{GS} = 0$ | | | | |
| | PMBFJ308 | | 12 | - | 60 | mA |
| | PMBFJ309 | | 12 | - | 30 | mA |
| | PMBFJ310 | | 24 | - | 60 | mA |
| I_{GSS} | gate leakage current | $V_{GS} = -15\ \text{V}$; $V_{DS} = 0$ | - | - | -1 | nA |
| R_{DSon} | drain-source on-state resistance | $V_{GS} = 0$; $V_{DS} = 100\ \text{mV}$ | - | 50 | - | Ω |
| $ y_{fs} $ | forward transfer admittance | $I_D = 10\ \text{mA}$; $V_{DS} = 10\ \text{V}$ | 10 | - | - | mS |
| $ y_{os} $ | common source output admittance | $I_D = 10\ \text{mA}$; $V_{DS} = 10\ \text{V}$ | - | - | 250 | μS |

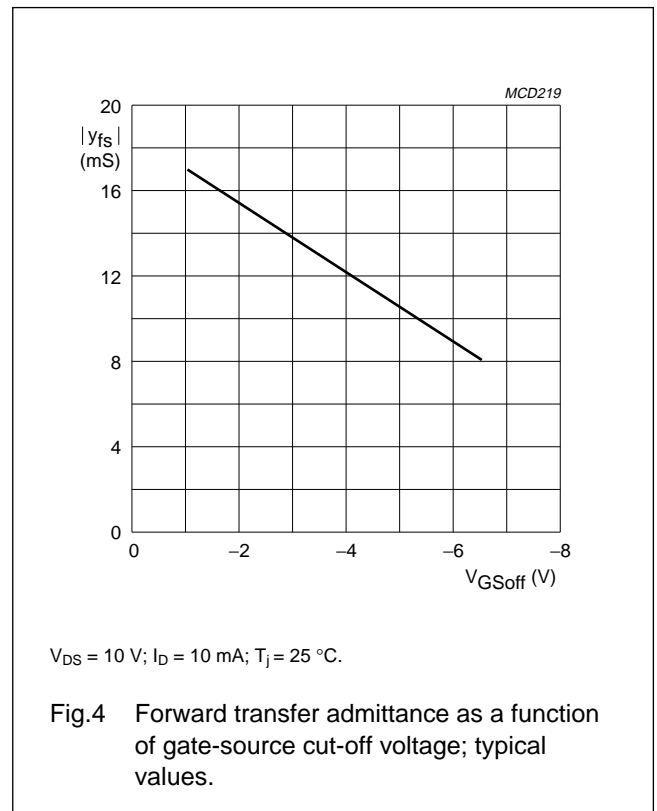
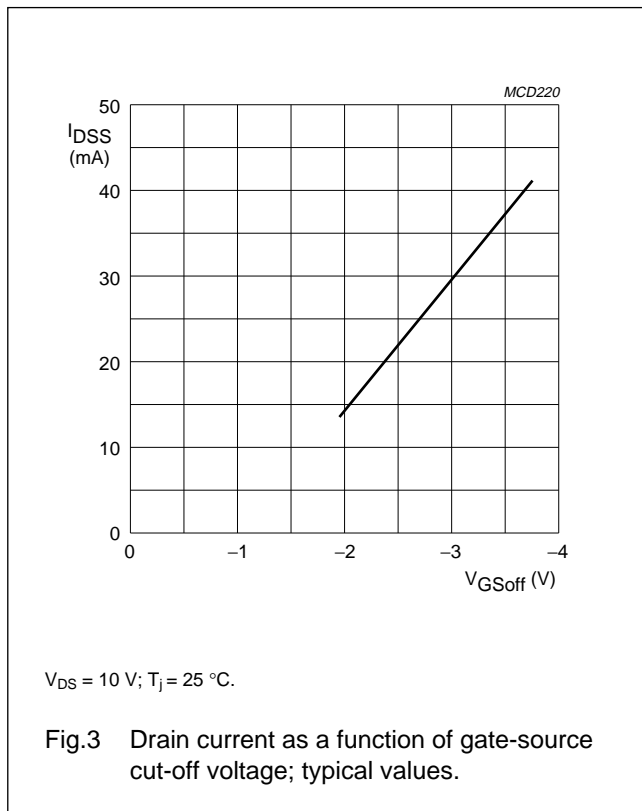
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DYNAMIC CHARACTERISTICS

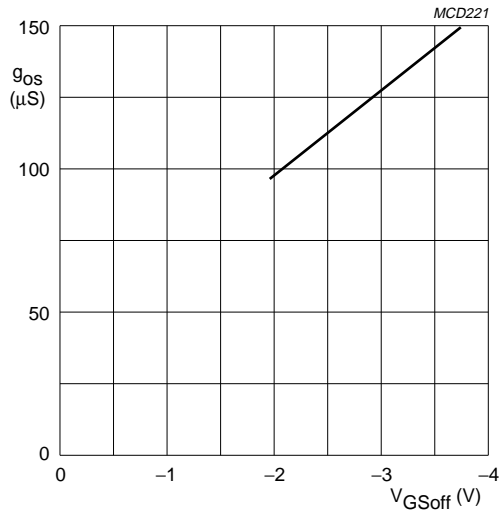
$T_j = 25\text{ }^\circ\text{C}$; unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | TYP. | MAX. | UNIT |
|----------|------------------------------------|--|------|------|------------------------|
| C_{is} | input capacitance | $V_{DS} = 10\text{ V}; V_{GS} = -10\text{ V}; f = 1\text{ MHz}$ | 3 | 5 | pF |
| | | $V_{DS} = 10\text{ V}; V_{GS} = 0; T_{amb} = 25\text{ }^\circ\text{C}$ | 6 | – | pF |
| C_{rs} | reverse transfer capacitance | $V_{DS} = 0; V_{GS} = -10\text{ V}; f = 1\text{ MHz}$ | 1.3 | 2.5 | pF |
| g_{is} | common source input conductance | $V_{DS} = 10\text{ V}; I_D = 10\text{ mA}; f = 100\text{ MHz}$ | 200 | – | μS |
| | | $V_{DS} = 10\text{ V}; I_D = 10\text{ mA}; f = 450\text{ MHz}$ | 3 | – | mS |
| g_{fs} | common source transfer conductance | $V_{DS} = 10\text{ V}; I_D = 10\text{ mA}; f = 100\text{ MHz}$ | 13 | – | mS |
| | | $V_{DS} = 10\text{ V}; I_D = 10\text{ mA}; f = 450\text{ MHz}$ | 12 | – | mS |
| g_{rs} | common source reverse conductance | $V_{DS} = 10\text{ V}; I_D = 10\text{ mA}; f = 100\text{ MHz}$ | –30 | – | μS |
| | | $V_{DS} = 10\text{ V}; I_D = 10\text{ mA}; f = 450\text{ MHz}$ | –450 | – | μS |
| g_{os} | common source output conductance | $V_{DS} = 10\text{ V}; I_D = 10\text{ mA}; f = 100\text{ MHz}$ | 150 | – | μS |
| | | $V_{DS} = 10\text{ V}; I_D = 10\text{ mA}; f = 450\text{ MHz}$ | 400 | – | μS |
| V_n | equivalent input noise voltage | $V_{DS} = 10\text{ V}; I_D = 10\text{ mA}; f = 100\text{ Hz}$ | 6 | – | nV/ $\sqrt{\text{Hz}}$ |



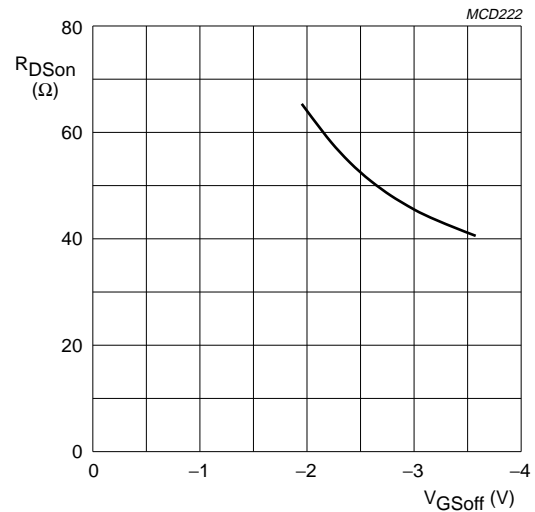
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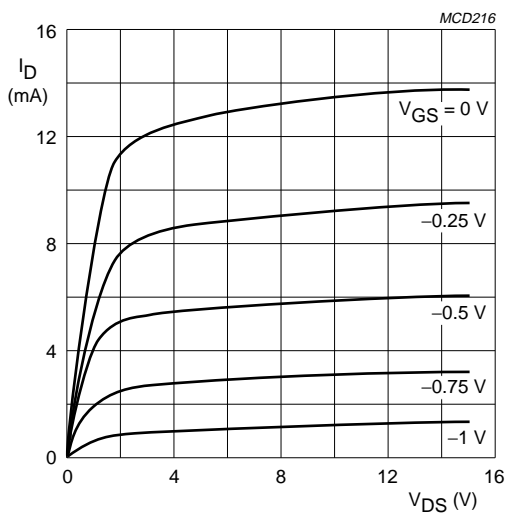
$V_{DS} = 10\text{ V}; I_D = 10\text{ mA}; T_j = 25\text{ }^\circ\text{C}.$

Fig.5 Common-source output conductance as a function of gate-source cut-off voltage; typical values.



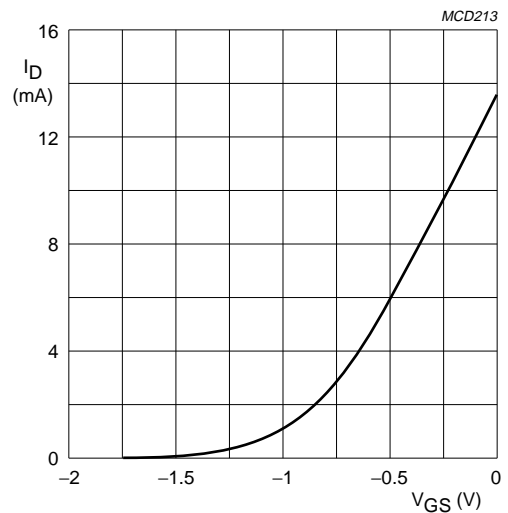
$V_{DS} = 100\text{ mV}; V_{GS} = 0; T_j = 25\text{ }^\circ\text{C}.$

Fig.6 Drain-source on-state resistance as a function of gate-source cut-off voltage; typical values.



$T_j = 25\text{ }^\circ\text{C}.$

Fig.7 Typical output characteristics; PMBFJ308.

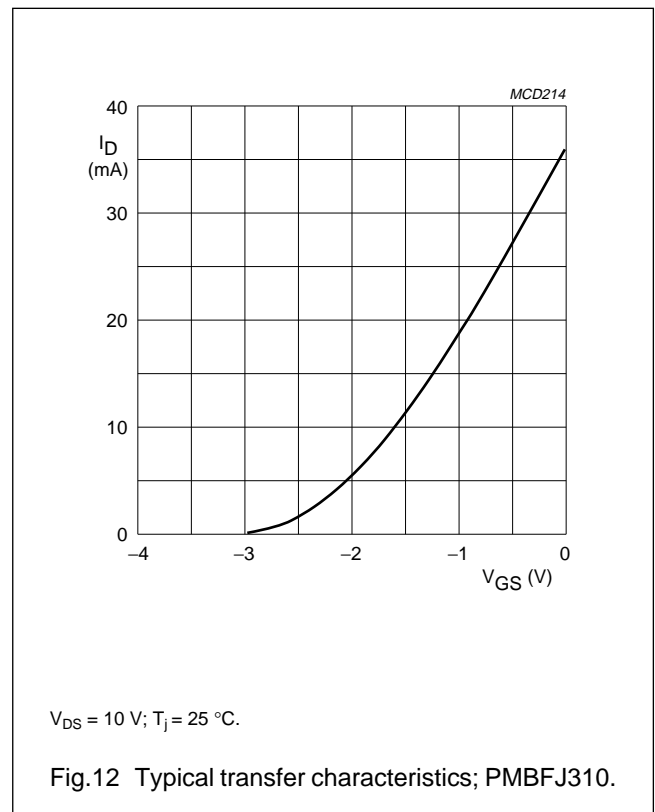
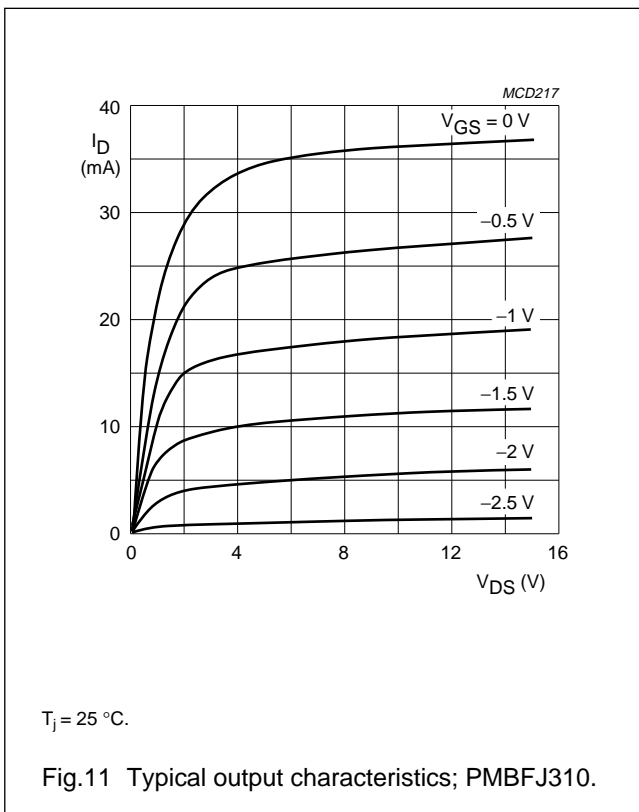
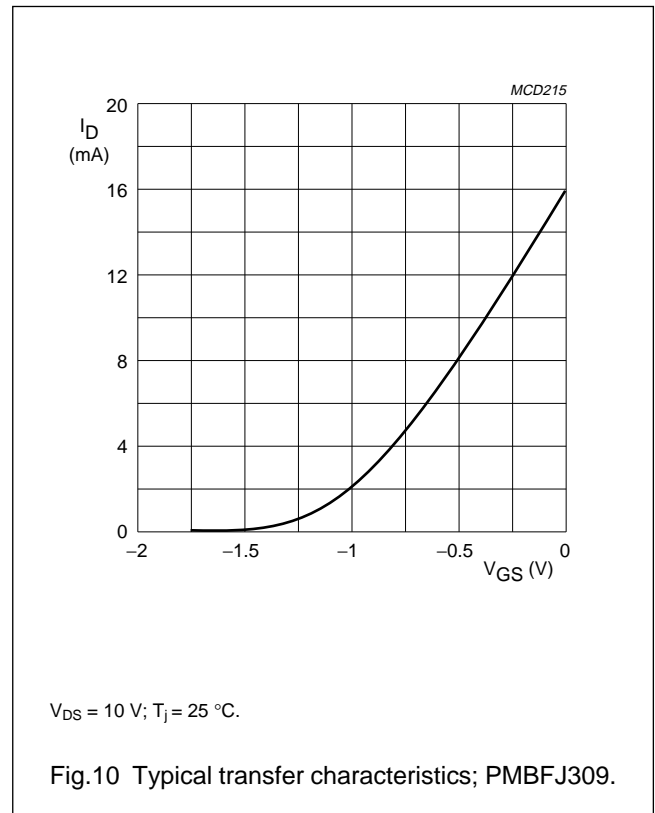
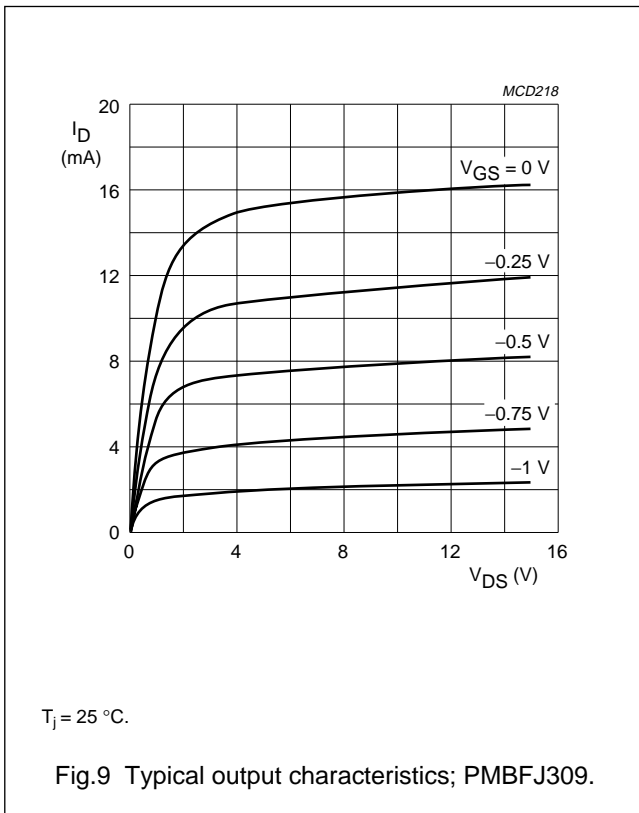


$V_{DS} = 10\text{ V}; T_j = 25\text{ }^\circ\text{C}.$

Fig.8 Typical transfer characteristics; PMBFJ308.

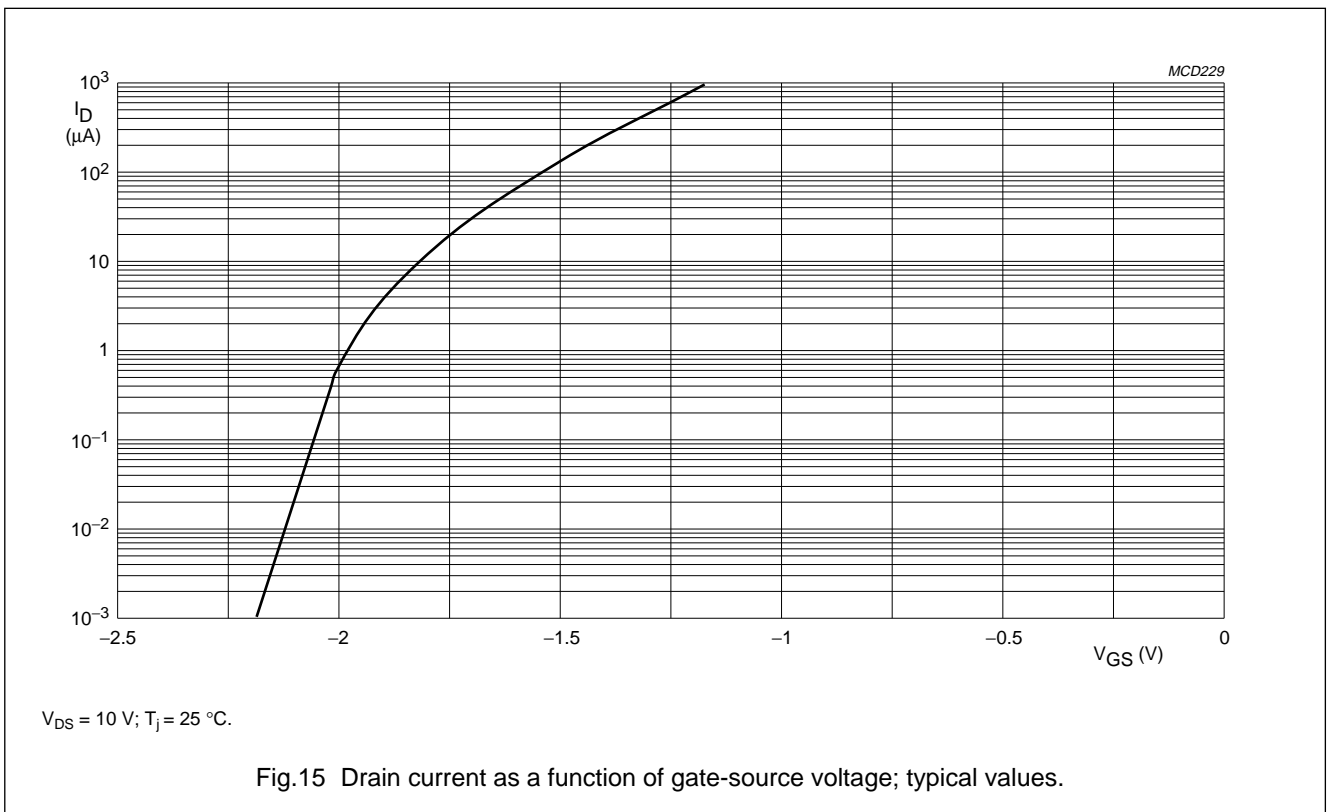
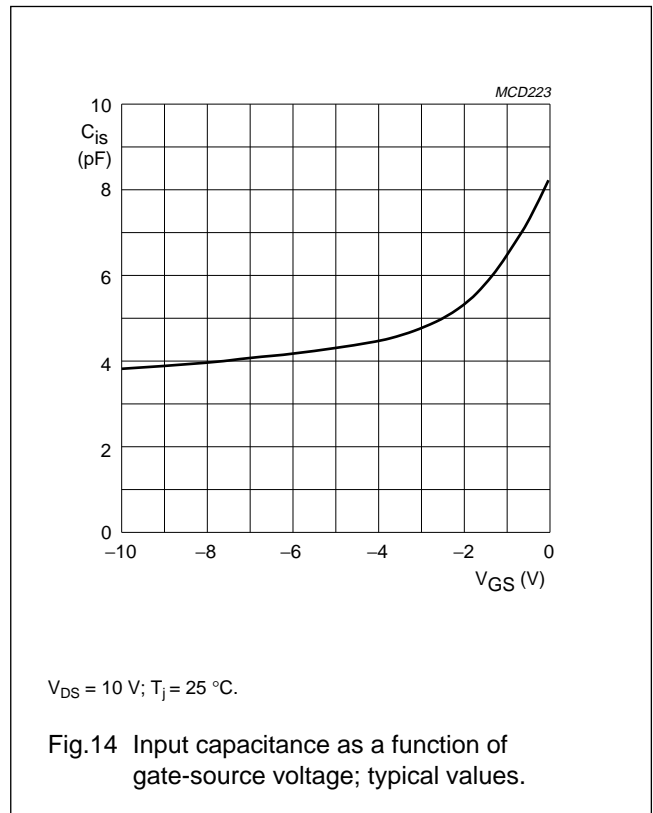
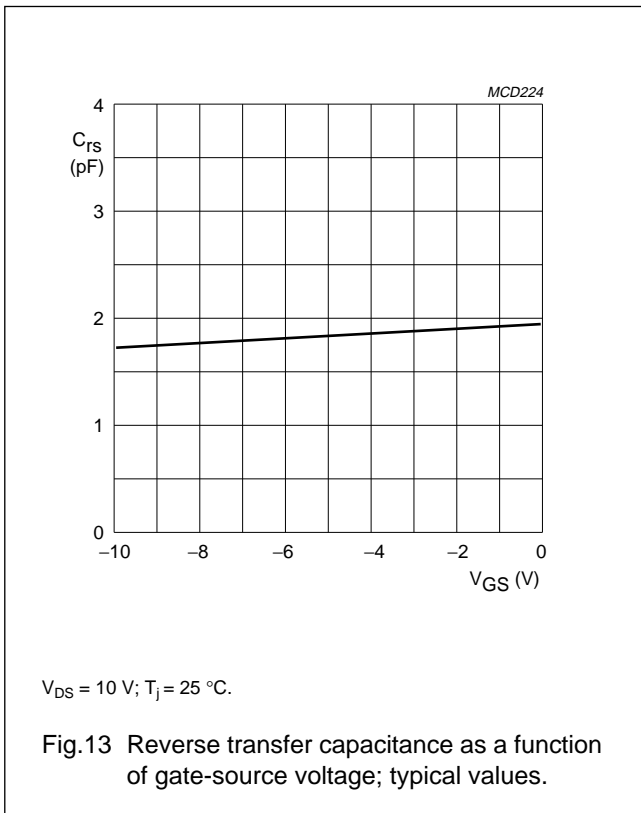
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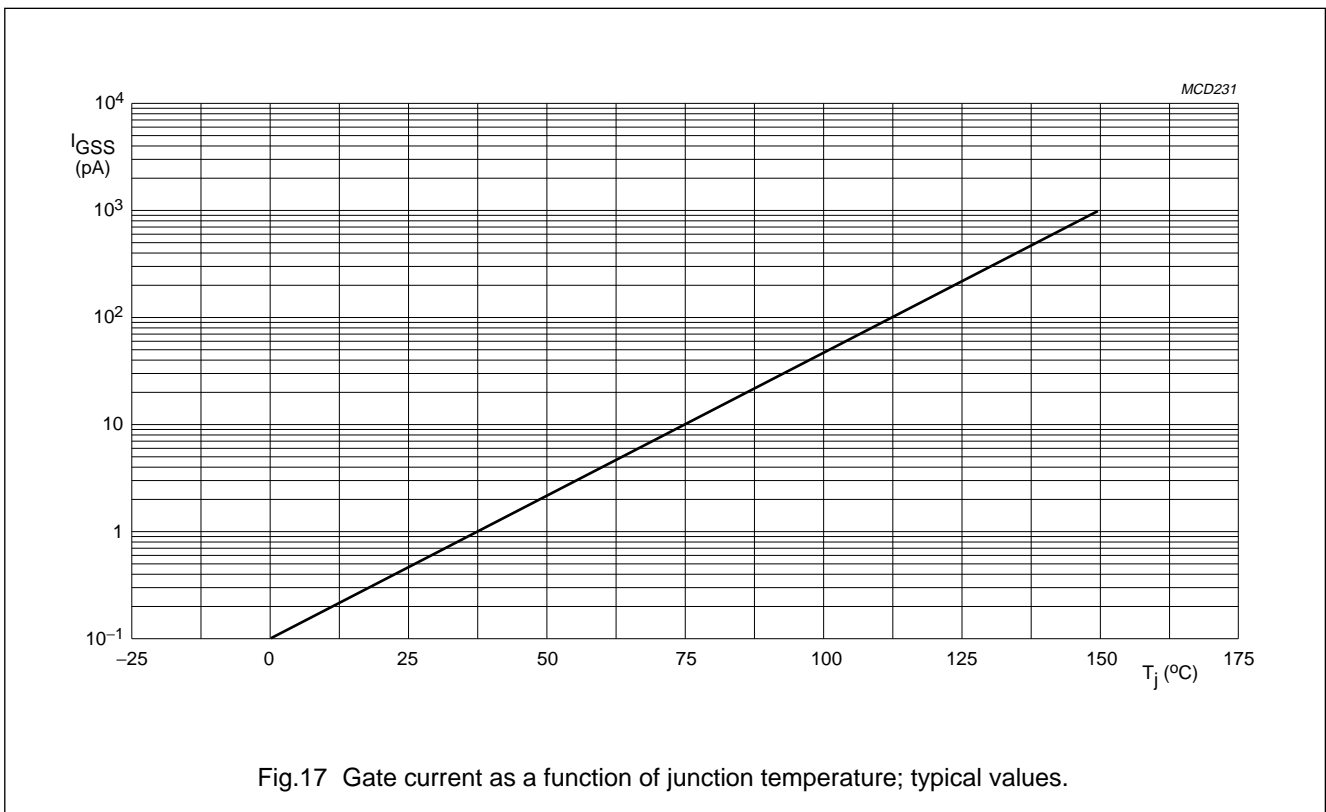
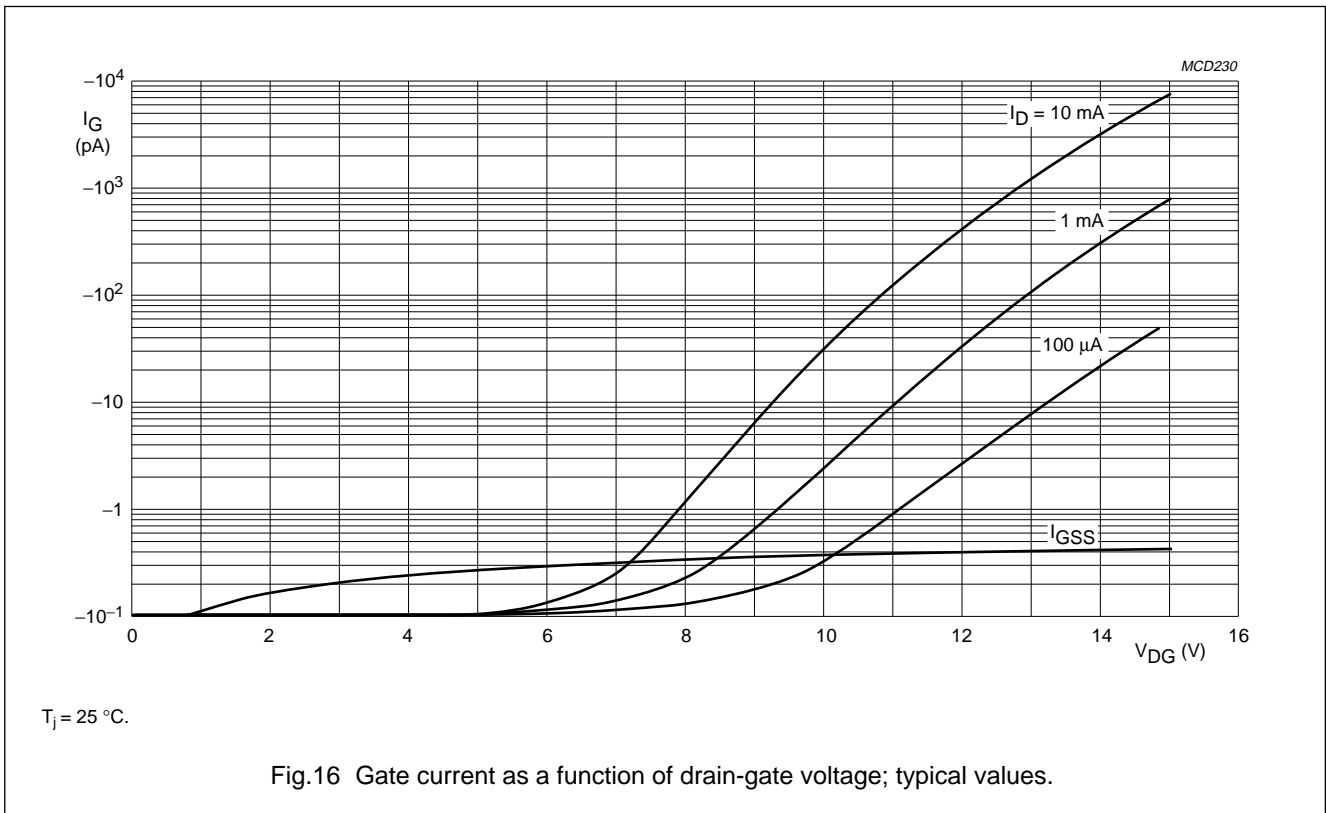
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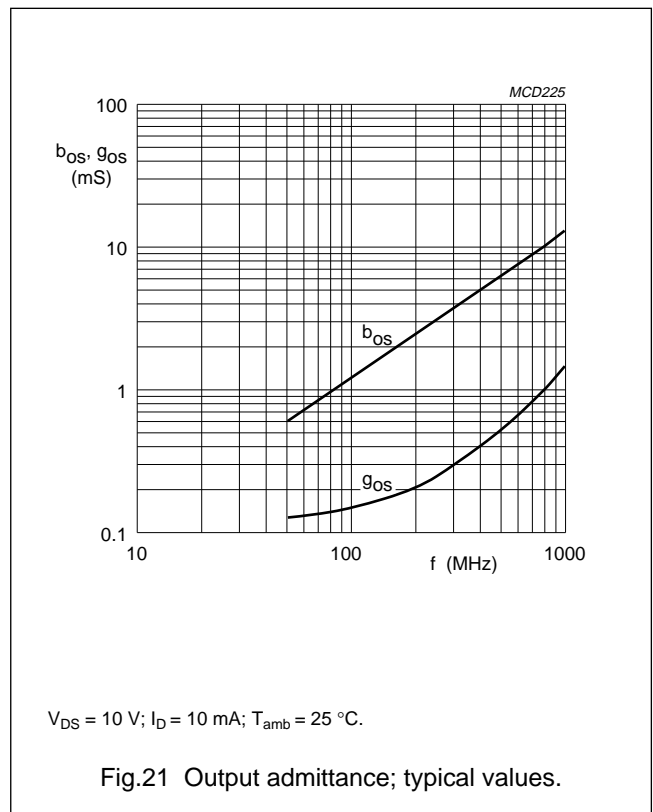
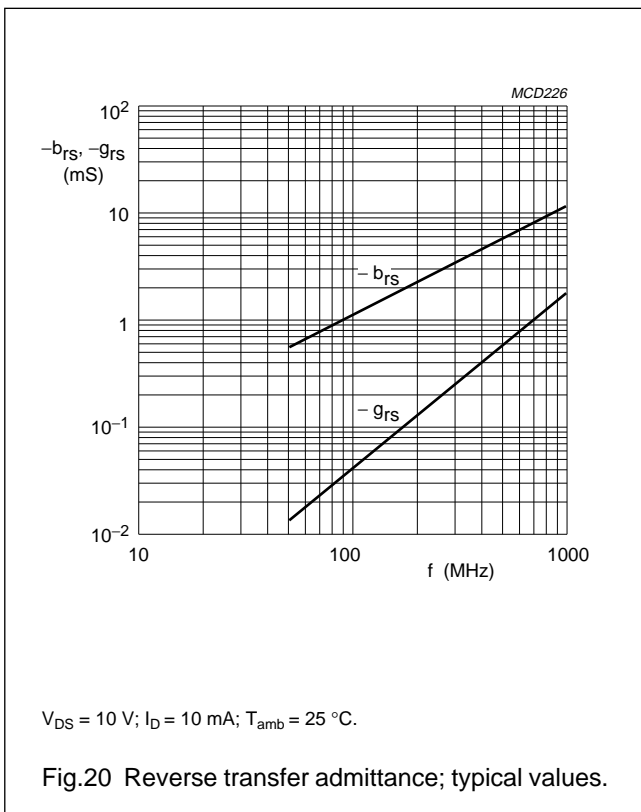
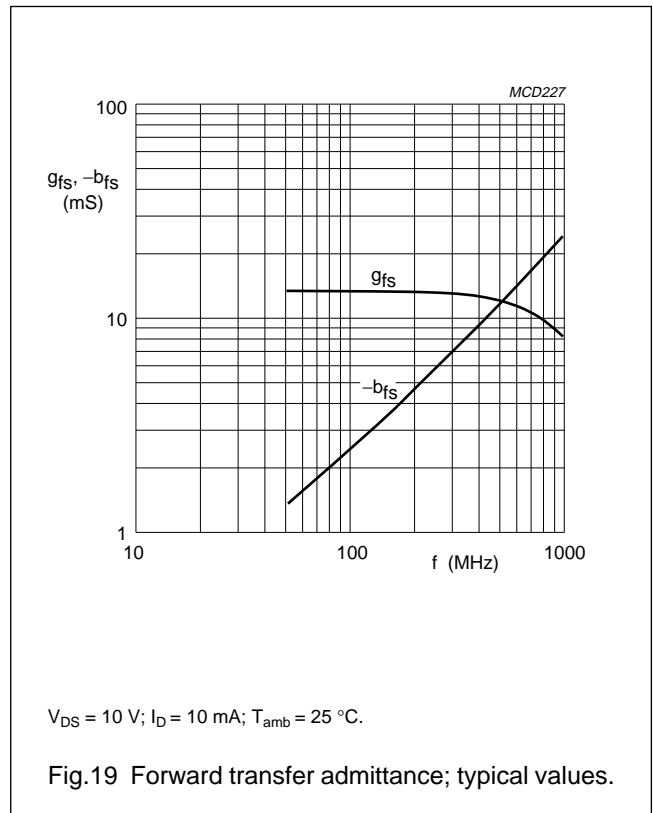
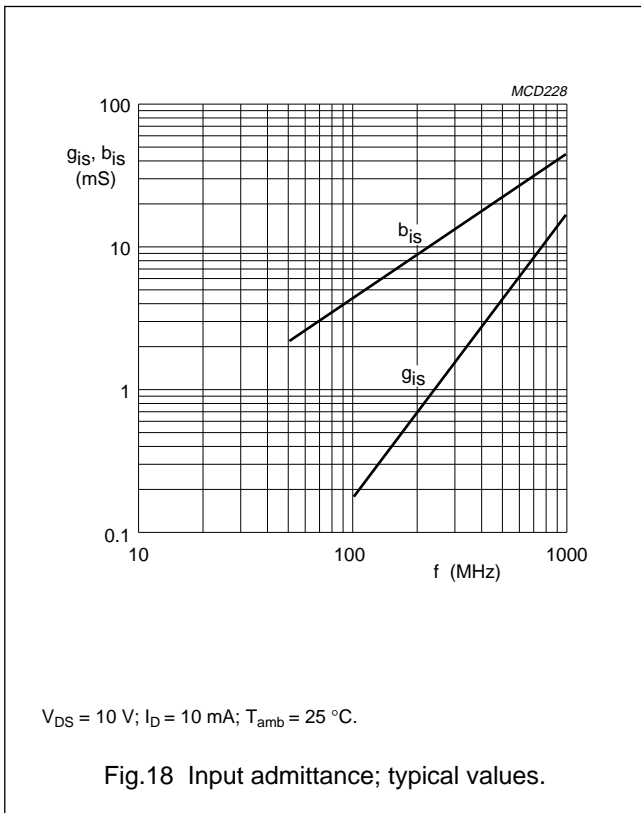
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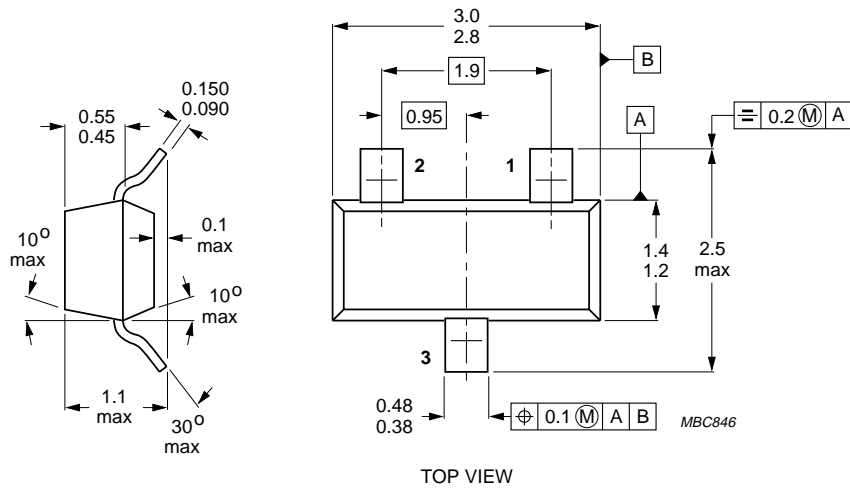
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PACKAGE OUTLINE



Dimensions in mm.

Fig.22 SOT 23.

N-channel silicon field-effect transistors

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PMBFJ310**DEFINITIONS**

| Data Sheet Status | |
|---|---|
| Objective specification | This data sheet contains target or goal specifications for product development. |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification | This data sheet contains final product specifications. |
| Limiting values | |
| Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability. | |
| Application information | |
| Where application information is given, it is advisory and does not form part of the specification. | |

LIFE SUPPORT APPLICATIONS

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